ISoIRS 2027

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ISoIRS 2027

7th International Symposium on Intelligent Robotic Systems & 2nd Embodied Intelligence and World Model workshop

April 23-25, 2027 | Shenzhen, China

The 7th International Symposium on Intelligent Robotic Systems (ISoIRS'27) & the 2nd Embodied Intelligence and World Model workshop (EIWM'27)ce and World Model workshop will be held in Shenzhen, China on April 23-25, 2027. They are organized by UESTC Shenzhen Institute for Advanced Study, co-organized by University of Nottingham, Edinburgh Napier University, The Hong Kong Polytechnic University, Qingdao Agricultural University, Dongguan University of Technology, Hebei University of Technology and University of Glasgow.

Keynote Speakers

Guang-Ren Duan MCAS, FIEEE, FIET, FIFAC
Harbin Institute of Technology, China

Gary Yen FIEEE, FIET, FIAPR
Oklahoma State University, USA / *Sichuan University*, China

Eric Rogers FIEEE, FIET, FIMechE
University of Southampton, UK

Guo-Ping Liu MAE, FIEEE, FIET, FCAA
Southern University of Science and Technology, China

Wen-Hua Chen FIEEE, FIET, FIMechE
Hong Kong Polytechnic University, China

Call For Papers

- **Core Intelligent Technologies and Algorithms**
  - Artificial Intelligence
  - Computational Intelligence
  - Expert Systems and Knowledge-Based Systems
- **Intelligent Robot Systems and Components**
  - Robot Mechanisms and Design
  - Robot Sensors and Actuators
  - Neural Processing Units (NPU) and Controllers

more topics

Publication

Registered and presented full papers will be included in the ISoIRS 2027 digital conference proceedings and submitted to major citation databases (including, but not limited to Ei Compendex and Scopus) for review and indexing.

Note: All accepted papers must be presented at the conference. No-show papers will be excluded from the conference proceedings.

Submission

ISoIRS 2027 will only consider submissions of original and previously unpublished papers. Please note that submitted papers must not substantially overlap with papers that have already been published or are currently under review for publication in a journal or conference proceedings. Please note that if you plan to submit a full paper for publication, there is no need to submit an abstract first. You can submit the full paper directly once it is completed.

Committee

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Jiawei Wu, *Shenzhen Institute for Advanced Study, UESTC*, China

Key Dates

The First Round

- Abstract Submission Due: November 11, 2026
- Full Paper Submission Due: November 26, 2026
- Author Notification: January 21, 2027
- Registration Due: February 21, 2027
- Final Paper Submission Due: March 8, 2027

Organized by: 电子科技大学(深圳)高等研究院 Shenzhen Institute for Advanced Study, UESTC

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